

## P-Channel 12-V (D-S) MOSFET

### PRODUCT SUMMARY

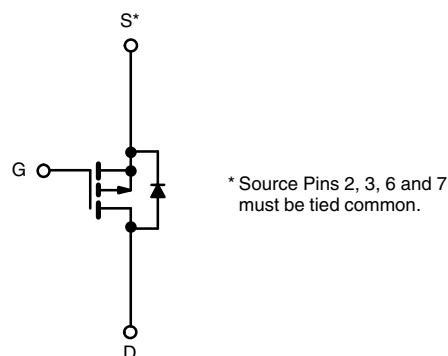
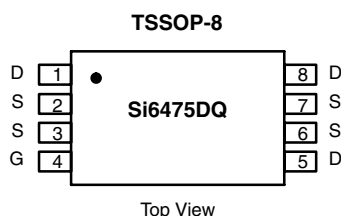
$V_{DS}$ (V)	$R_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
- 12	0.011 at $V_{GS} = - 4.5$ V	- 10
	0.0135 at $V_{GS} = - 2.5$ V	- 9
	0.017 at $V_{GS} = - 1.8$ V	- 8

### FEATURES

- Halogen-free
- TrenchFET® Power MOSFETs



**RoHS**  
COMPLIANT



**Ordering Information:** Si6475DQ-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted

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Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	- 12		V
Gate-Source Voltage		$V_{GS}$	$\pm 8$		
Continuous Drain Current ( $T_J = 150\text{ }^{\circ}\text{C}$ ) <sup>a</sup>	$T_A = 25\text{ }^{\circ}\text{C}$	$I_D$	- 10	- 7.8	A
	$T_A = 70\text{ }^{\circ}\text{C}$		- 8	- 6.2	
Pulsed Drain Current (10 $\mu\text{s}$ Pulse Width)		$I_{DM}$	- 30		
Continuous Source Current (Diode Conduction) <sup>a</sup>		$I_S$	- 1.5	- 0.95	
Maximum Power Dissipation <sup>a</sup>	$T_A = 25\text{ }^{\circ}\text{C}$	$P_D$	1.75	1.08	W
	$T_A = 70\text{ }^{\circ}\text{C}$		1.14	0.69	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	- 55 to 150		$^{\circ}\text{C}$

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	$R_{thJA}$	55	70	°C/W
		95	115	
Maximum Junction-to-Foot (Drain)	$R_{thJF}$	35	45	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

<b>SPECIFICATIONS</b> $T_J = 25^\circ\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = -5\text{ mA}$	-0.45			V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 8\text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -9.6\text{ V}$ , $V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
		$V_{DS} = -9.6\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 70^\circ\text{C}$			-10	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} = -5\text{ V}$ , $V_{GS} = -4.5\text{ V}$	20			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}$ , $I_D = -10\text{ A}$		0.009	0.011	$\Omega$
		$V_{GS} = -2.5\text{ V}$ , $I_D = -9\text{ A}$		0.011	0.0135	
		$V_{GS} = -1.8\text{ V}$ , $I_D = -8\text{ A}$		0.014	0.017	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -15\text{ V}$ , $I_D = -10\text{ A}$		50		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = -1.5\text{ A}$ , $V_{GS} = 0\text{ V}$		-0.68	-1.1	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = -6\text{ V}$ , $V_{GS} = -4.5\text{ V}$ , $I_D = -10\text{ A}$		49.5	70	nC
Gate-Source Charge	$Q_{gs}$			7.7		
Gate-Drain Charge	$Q_{gd}$			8.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -6\text{ V}$ , $R_L = 6\ \Omega$ $I_D \cong -1\text{ A}$ , $V_{GEN} = -4.5\text{ V}$ , $R_G = 6\ \Omega$		56	85	ns
Rise Time	$t_r$			62	100	
Turn-Off Delay Time	$t_{d(off)}$			300	450	
Fall Time	$t_f$			185	270	
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = -1.5\text{ A}$ , $dI/dt = 100\text{ A}/\mu\text{s}$		90	150	

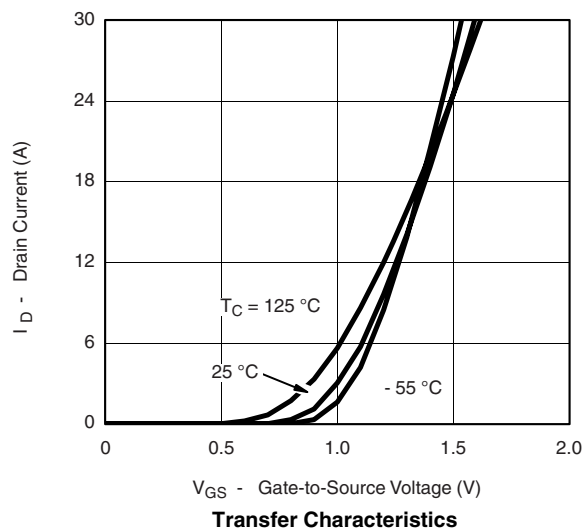
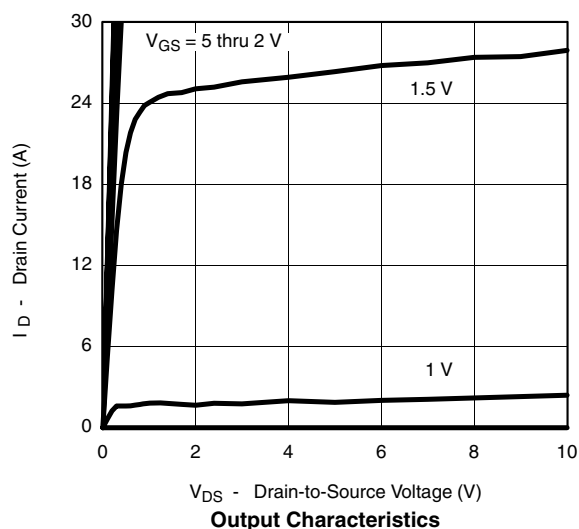
Notes:

a. Pulse test; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .

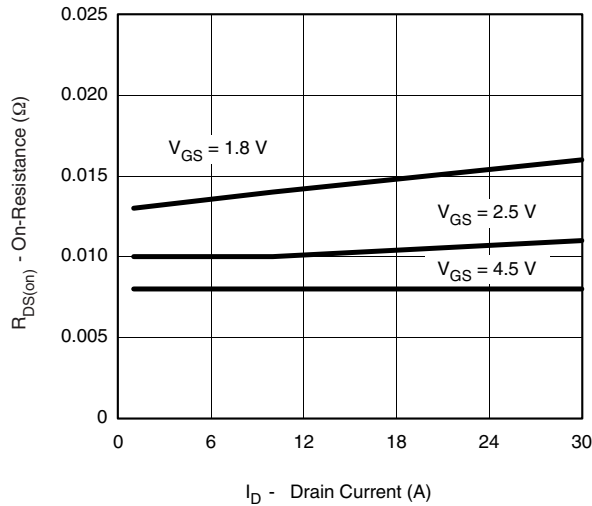
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

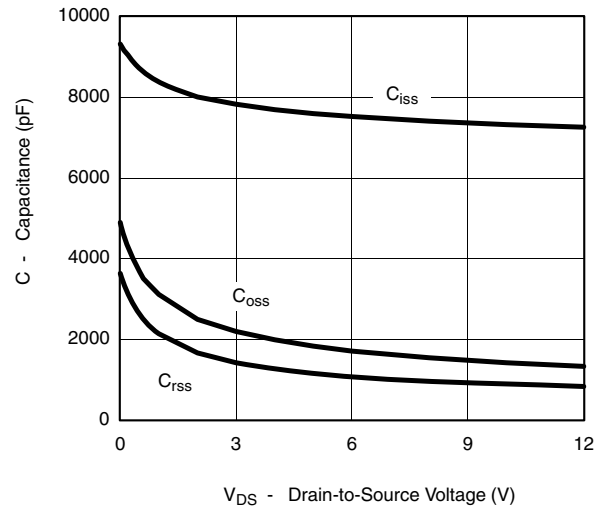
## TYPICAL CHARACTERISTICS $25^\circ\text{C}$ , unless otherwise noted



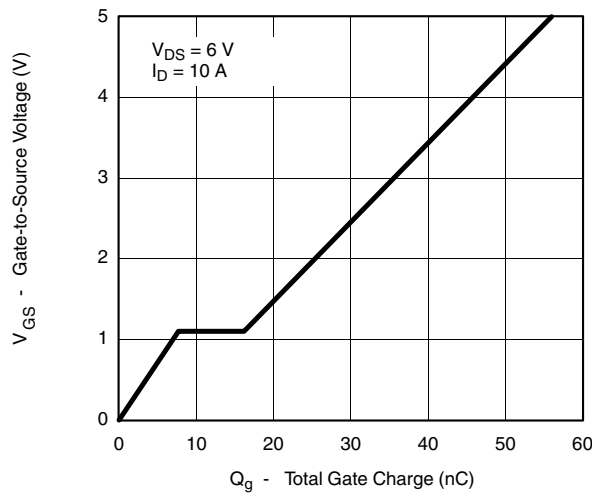
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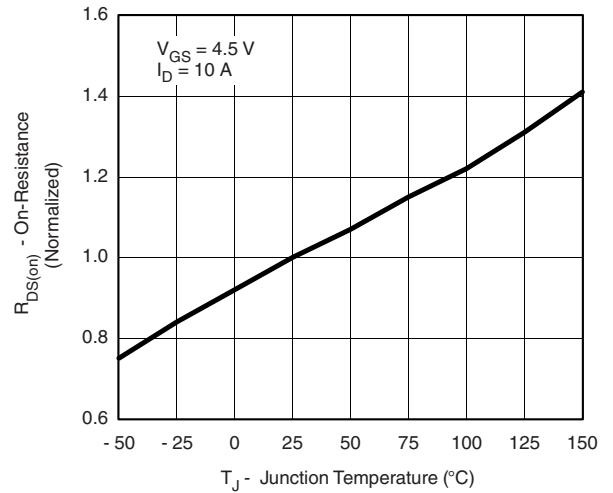
On-Resistance vs. Drain Current



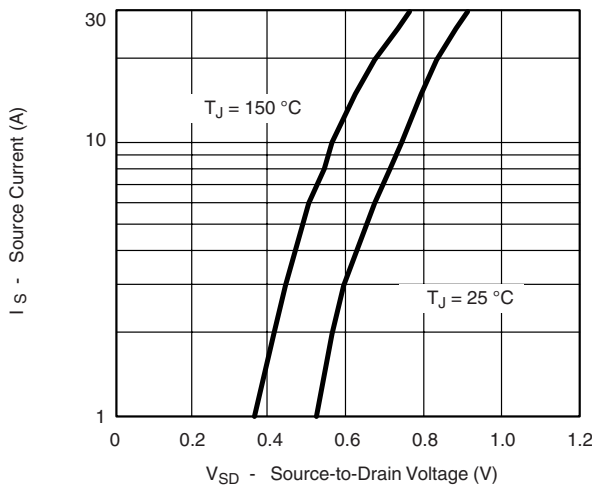
Capacitance



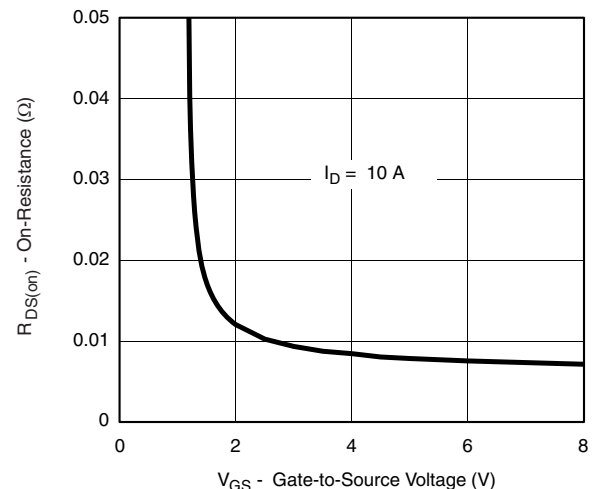
Gate Charge



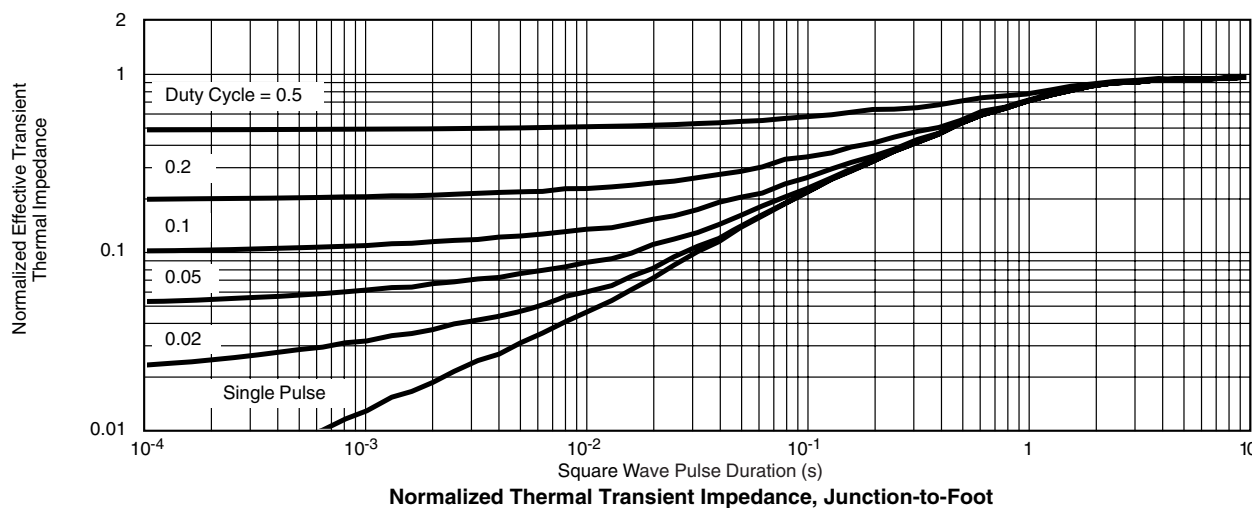
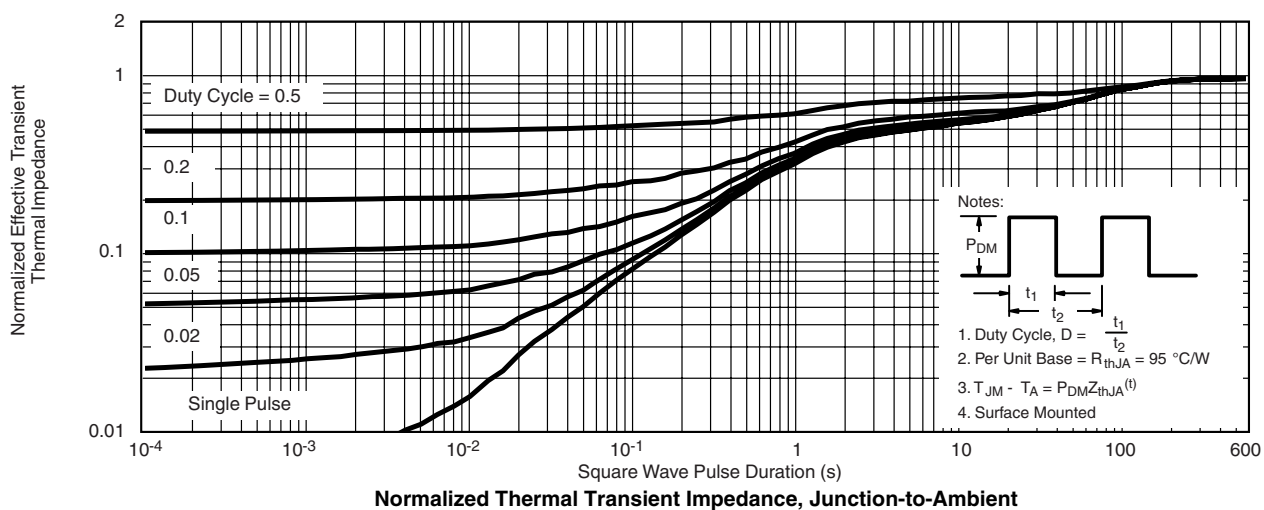
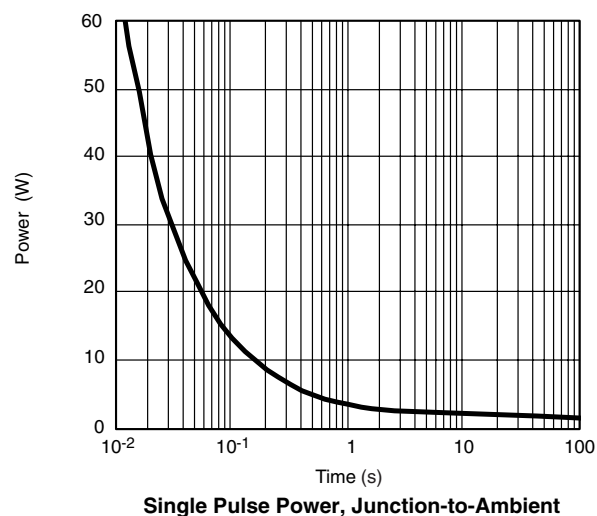
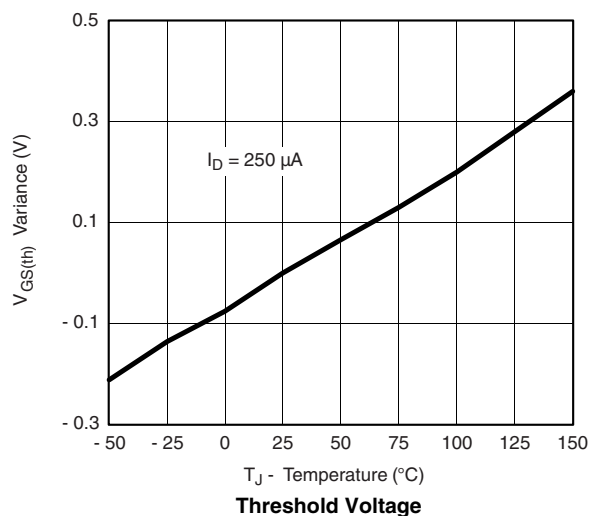
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

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